



General Description

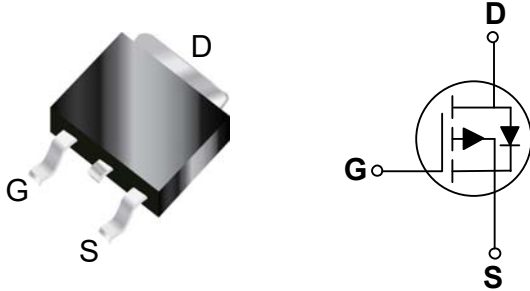
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV_{DSS}	$R_{DS(ON)}$	I_D
-40 V	35 mΩ	-25 A

Features

- $R_{DS(ON)} \leq 35m\Omega @ V_{GS} = -10V$
- Fast Switching
- Green Device Available
- Reliable and Rugged

TO-263 Pin Configuration



Applications

- Synchronous Rectification
- Load Switch

Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-40	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current - Continuous ($T_C=25^\circ C$)	-25	A
I_{DM}	Drain Current - Pulsed (NOTE 1)	-61	A
EAS	Single Pulse Avalanche Energy (L=0.1mH)	12.8	mJ
IAS	Single Pulse Avalanche Current (L=0.1mH)	-16	A
P_D	Power Dissipation ($T_C=25^\circ C$)	38	W
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
Marking Code		PD035	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	62.5	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction to Case	3.3	$^\circ C/W$

**Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-40	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=-32V, V_{GS}=0V$	---	---	-1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=-10V, I_D=-10A$	---	---	35	m Ω
		$V_{GS}=-4.5V, I_D=-5A$	---	---	60	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=-250\mu A$	-1.0	---	-2.5	V
g_{fs}	Forward Transconductance	$V_{DS}=-5V, I_D=-5A$	---	14.5	---	S

Dynamic and switching Characteristics (NOTE 3)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q_g	Total Gate Charge	$V_{DS}=-20V, V_{GS}=-10V, I_D=-10A$	---	26.9	---	nC
Q_{gs}	Gate-Source Charge		---	4.88	---	
Q_{gd}	Gate-Drain Charge		---	4.51	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=-30V, V_{GS}=-10V, R_{GEN}=6\Omega, I_D=-1A$	---	4.8	---	nS
T_r	Rise Time		---	17.6	---	
$T_{d(off)}$	Turn-Off Delay Time		---	88.5	---	
T_f	Fall Time		---	48.8	---	
C_{iss}	Input Capacitance	$V_{DS}=-20V, V_{GS}=0V, F=1\text{MHz}$	---	1316	---	pF
C_{oss}	Output Capacitance		---	102	---	
C_{rss}	Reverse Transfer Capacitance		---	78	---	
R_g	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, F=1\text{MHz}$	---	11	---	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=-5A$	---	---	-1.1	V

NOTES :

1. Max. current is limited by junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production testing.



Characteristics Curves

FIG. 1-Drain Current

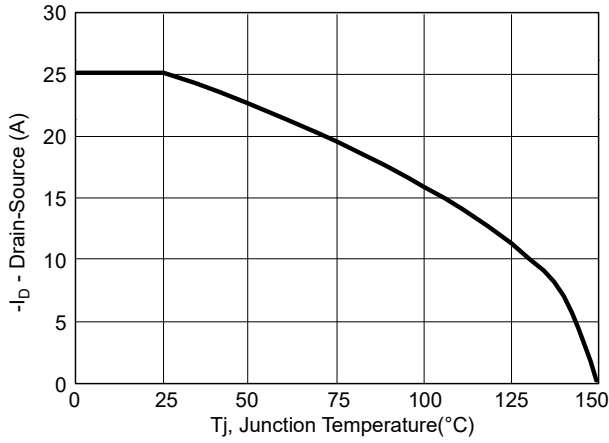


FIG. 2-Drain-Source On-Resistance

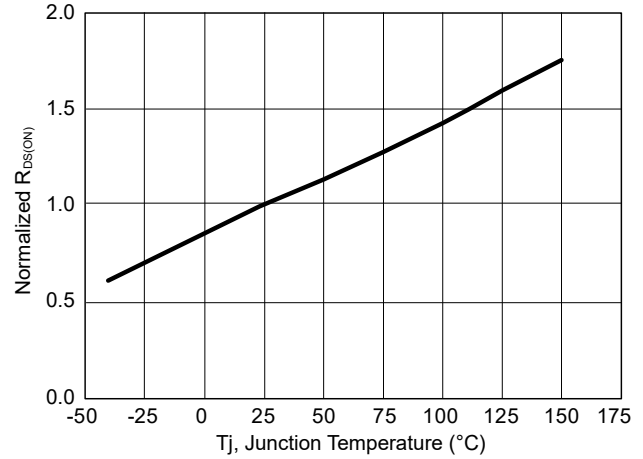


FIG. 3-Gate Threshold Voltage

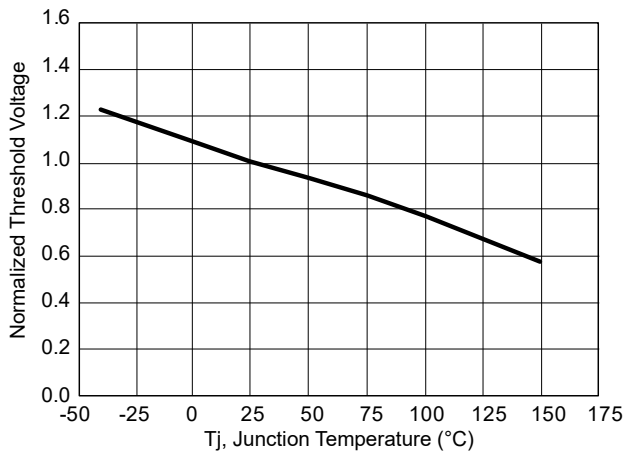


FIG. 4-Gate Charge Characteristics

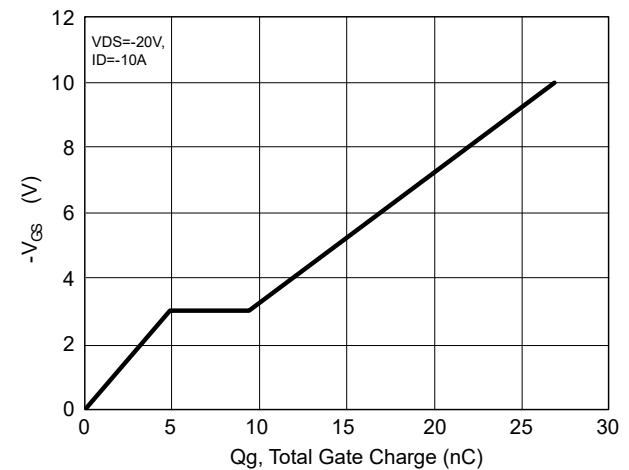


FIG. 5-Safe Operating Area

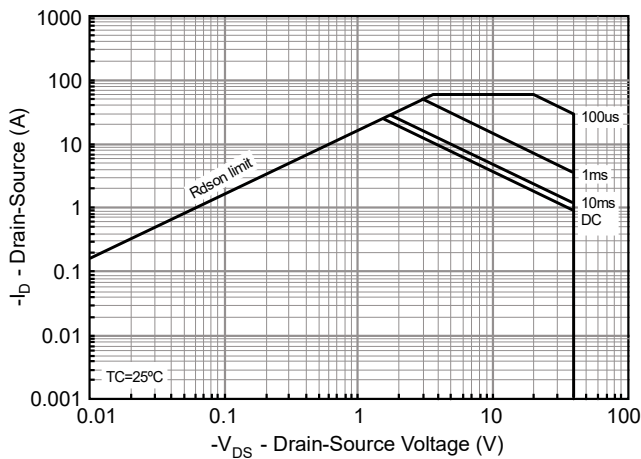
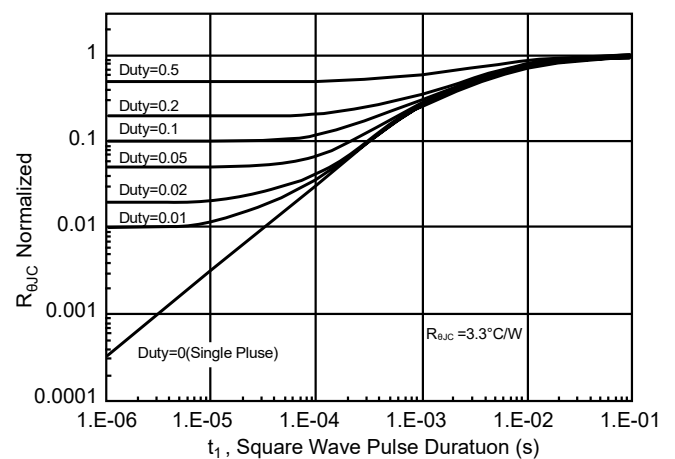
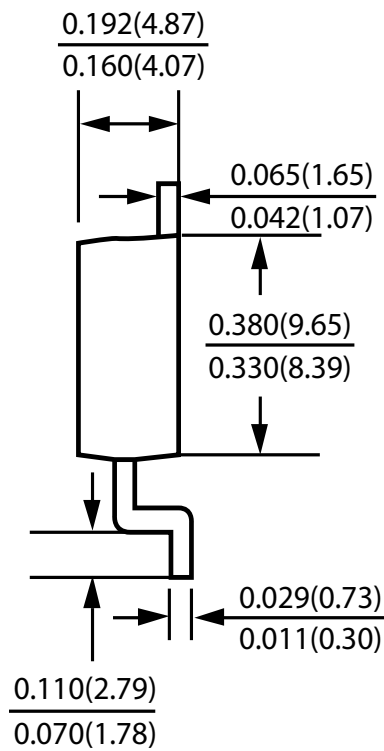
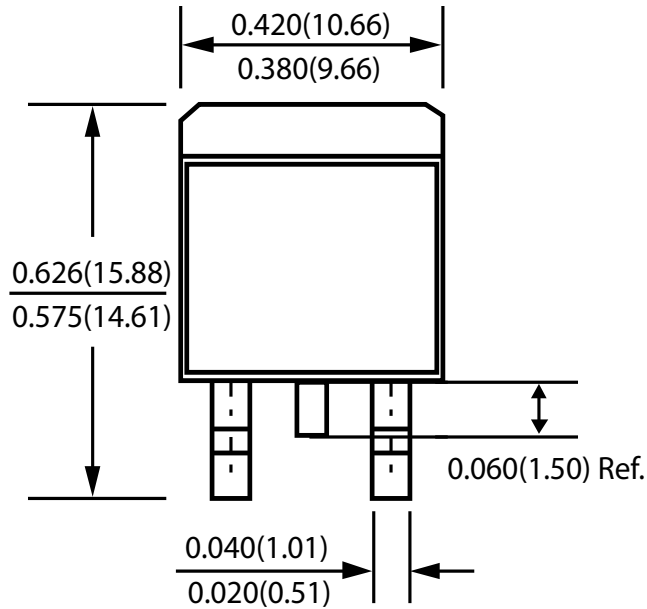


FIG. 6- Source-Drain Forward Voltage





Package Outline Dimensions



TO-263

Dimensions in inches and (millimeters)



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